Atty. Docket No.: **Application No.:** US Department 42390P11370 09/965,280 Patent and Trademark Office Applicant: Ohfuji et al. Filing Date: Form PTO-1449 (Modified) September 26, 2001 **US Patent Documents** Examiner's **Document** Sub-**Initials** Date Number Name Class Class Filing Date **Foreign Patent Documents** Examiner's **Document** Sub-**Initials** Number Date Country Class Class Translation Other Documents (Including Author, Title, Date, Pertinent Pages, etc.) Alexei L. Bogdanov, Use of SU-8 Negatvie Photoresist for Optical Mask Manufacturing MAX-Lab, University of Lund, SE-221 00, Lund Sweden. [online] Pages 1-11. http://www.maxlab.luy.se/beamlines/bld811. Proc. SPIE Vol. 3999. Pub. 2000. SPIE Volume 2512; Masumi Arai, Hiroyuki Inomata, Toshiharu Nishimura, Masa-aki Kurihara and Naoya Hayashi; "Application of Chemically Amplified Resists to Photomask Fabrication". Micro Products Research Laboratory, Micro Products Division, Dai Nippon Printing CO., Ltd., Japan. Pages 74-87. Pub. 1995. SPIE Volume 2793; A Chemically Amplified Resist Process For 0.25 u M Generation Photomasks; Mikio Katsumata, Hiroichi Kawahira, Minoru Sugara and Satoru Nozawa. MOS LSI Division, Semiconductor Company, Sony Corporation, Japan. Pages 96-104. Pub.1996. Examiner Date Considered Mohamedulla 3115705

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